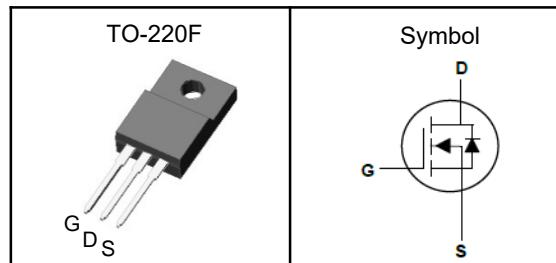


N-Channel Enhancement Mode MOSFET

Features

- Fast switching speed
- Reliable and Rugged
- ROHS Compliant
- 100% UIS and Rg Tested

Pin Description



Applications

- Power Management in Desktop Computer
- DC/DC Converters

V_{DSS}	650	V
$R_{DS(ON)-Typ}$	1100	$m\Omega$
I_D	7	A

Absolute Maximum Ratings ($T_J=25^\circ C$, Unless Otherwise Noted)

Symbol	Parameter	N-Channel	Unit
V_{DSS}	Drain-Source Voltage	650	V
V_{GSS}	Gate-Source Voltage	± 30	V
T_J	Maximum Junction Temperature	-55 to 150	$^\circ C$
T_{STG}	Storage Temperature Range	-55 to 150	$^\circ C$
E_{AS}	Single Pulse Avalanche Energy ^③	230	mJ
$I_{DM}^{①}$	Pulse Drain Current Tested	28	A
I_D	Continuous Drain Current	$T_c=25^\circ C$	A
P_D	Maximum Power Dissipation	$T_c=25^\circ C$	W

Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{θJA}$	Thermal Resistance Junction-Ambient ₁ (Max)	62.5	$^\circ C/W$
$R_{θJC}$	Thermal Resistance Junction-Case ₁	1.98	$^\circ C/W$

Note ① : Max. current is limited by bonding wire.

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150°C.

Note ③ : Surface Mounted on 1in² FR-4 board with 1oz.

N-Channel Enhancement Mode MOSFET

Electrical Characteristics ($T_J=25^\circ\text{C}$, Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
Static Electrical Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_D=250\mu\text{A}$	650	---	---	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}}=650\text{V}$, $V_{\text{GS}}=0\text{V}$	---	---	1	μA
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$, $I_D=250\mu\text{A}$	2	---	4	V
I_{GSS}	Gate Leakage Current	$V_{\text{GS}}=\pm30\text{V}$, $V_{\text{DS}}=0\text{V}$	---	---	±100	nA
$R_{\text{DS(ON)}}$	Drain-Source On-state Resistance	$V_{\text{GS}}=10\text{V}$, $I_D=3.5\text{A}$	---	1100	1300	$\text{m}\Omega$
Dynamic Characteristics^⑤						
C_{iss}	Input Capacitance	$V_{\text{GS}}=0\text{V}$, $V_{\text{DS}}=25\text{V}$, Freq.=1MHz	---	1098	---	pF
C_{oss}	Output Capacitance		---	93	---	
C_{rss}	Reverse Transfer Capacitance		---	11	---	
$T_{\text{d(on)}}$	Turn-on Delay Time	$V_{\text{DD}}=325\text{V}$, $R_G=25\Omega$, $I_D=7\text{A}$	---	29	---	nS
T_r	Turn-on Rise Time		---	48	---	
$T_{\text{d(off)}}$	Turn-off Delay Time		---	39	---	
T_f	Turn-off Fall Time		---	33	---	
Q_g	Total Gate Charge	$V_{\text{DD}}=400\text{V}$, $V_{\text{GS}}=10\text{V}$, $I_D=7\text{A}$	---	20	---	nC
Q_{gs}	Gate-Source Charge		---	4	---	
Q_{gd}	Gate-Drain Charge		---	7	---	
Source-Drain Characteristics ($T_J=25^\circ\text{C}$)						
V_{SD}	Diode Forward Voltage ^②	$V_{\text{GS}}=0\text{V}$, $I_S=7\text{A}$, $T_J=25^\circ\text{C}$	---	---	1.4	V
t_{rr}	Reverse Recovery Time	$V_R=400\text{V}$, $I_S=7\text{A}$, $dI/dt=100\text{A}/\mu\text{s}$, $T_J=25^\circ\text{C}$	---	365	---	nS
Q_{rr}	Reverse Recovery Charge		---	3.4	---	nC

Note ④ : Pulse test (pulse width $\leq300\mu\text{s}$, duty cycle $\leq2\%$).

Note ⑤ : Guaranteed by design, not subject to production testing.

N-Channel Enhancement Mode MOSFET

Typical Characteristics

Figure 1. Output Characteristics

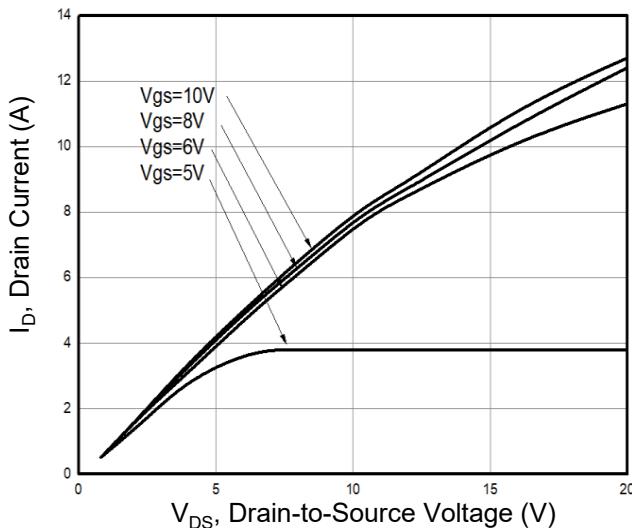


Figure 2. Transfer Characteristics

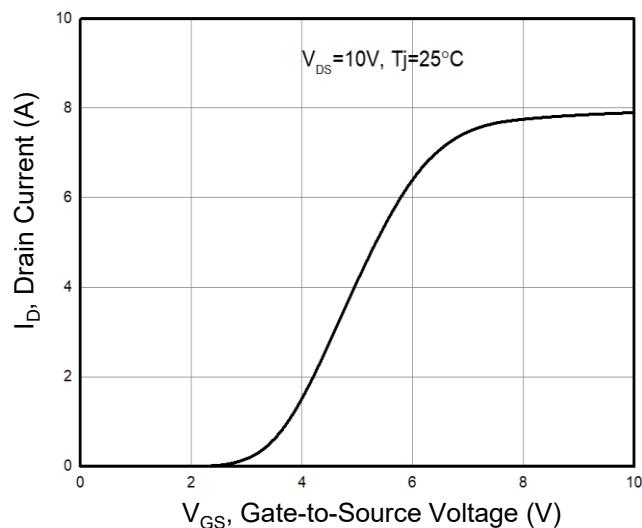


Figure 3. Drain Current vs. Temperature

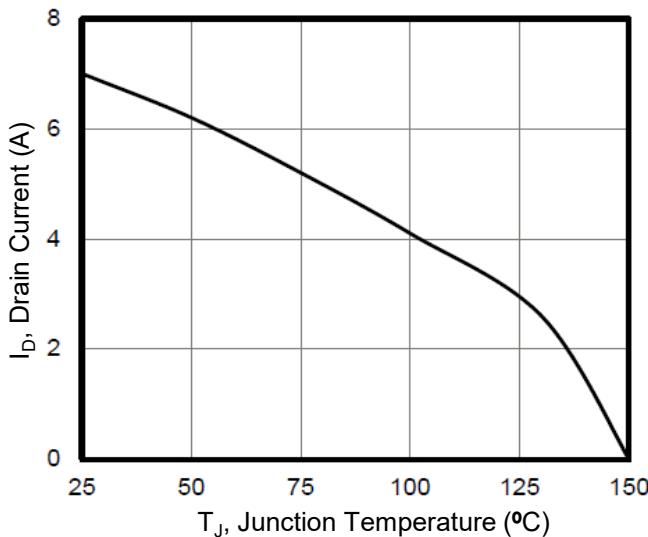


Figure 4. Capacitance

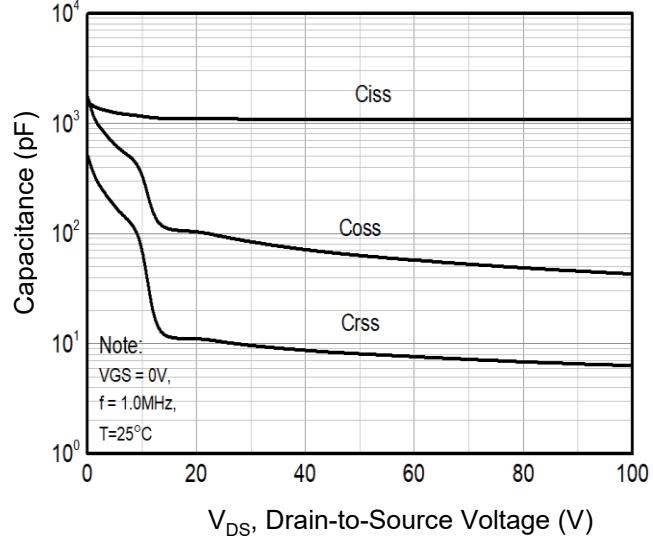


Figure 5. Gate Charge

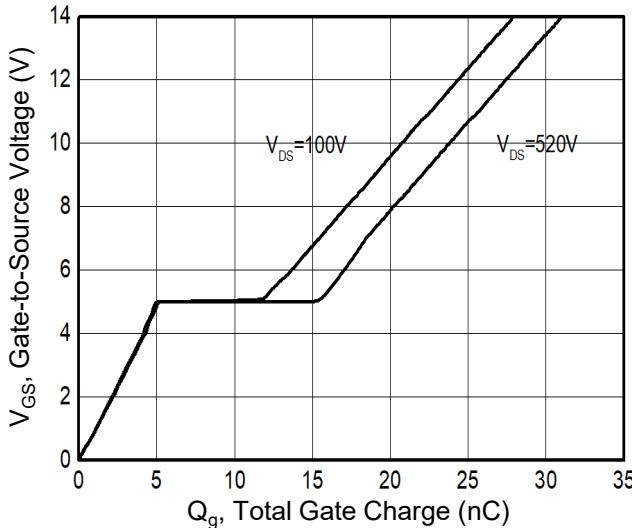
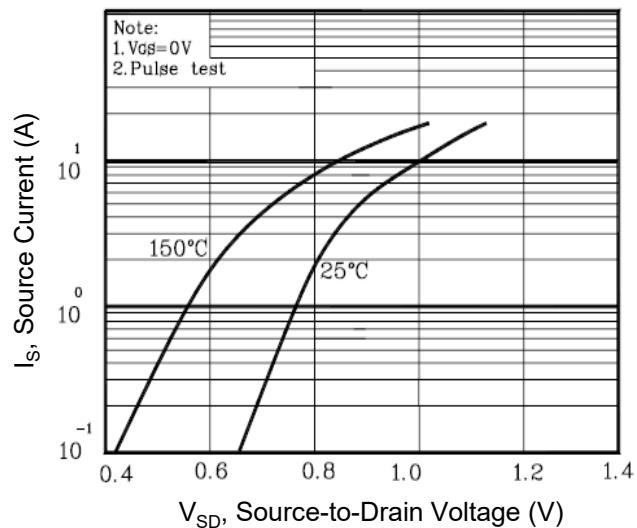


Figure 6. Body Diode Forward Voltage



N-Channel Enhancement Mode MOSFET

Figure 7. On-Resistance vs. Temperature

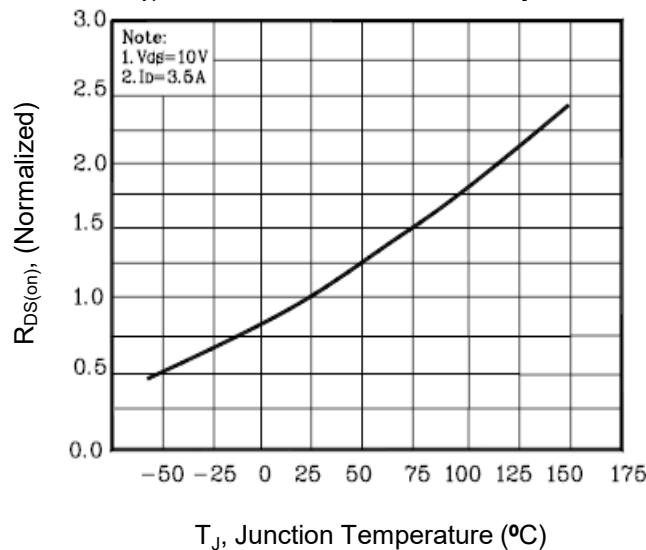
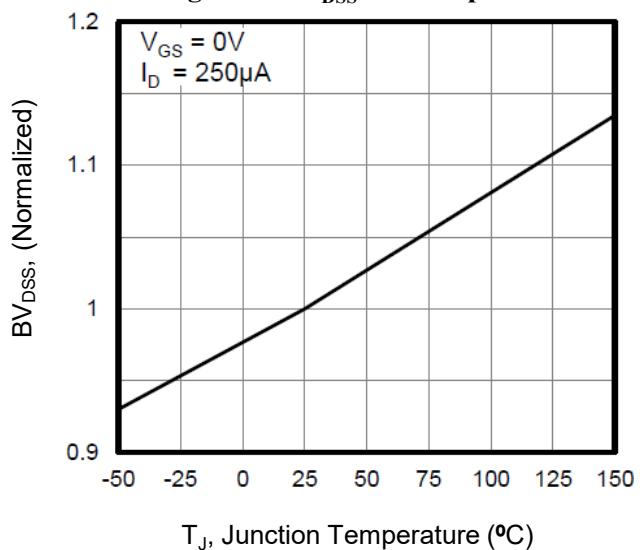
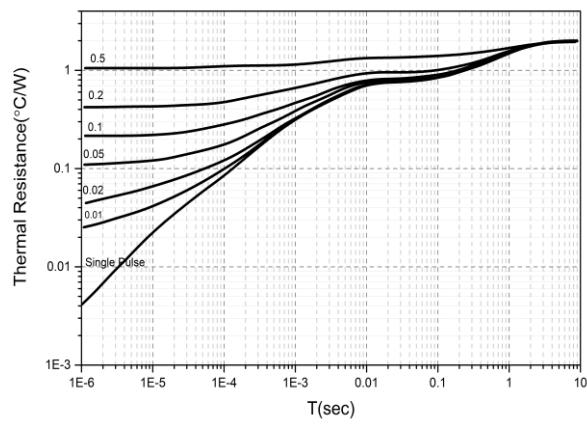


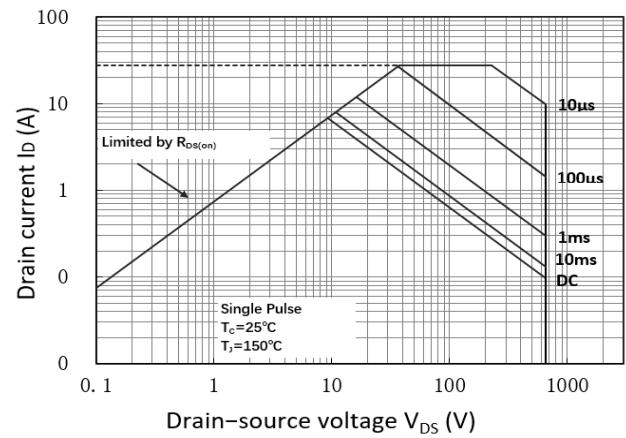
Figure 8. BV_{DSS} vs. Temperature



**Figure 9. Transient Thermal Impedance
(TO-220F)**

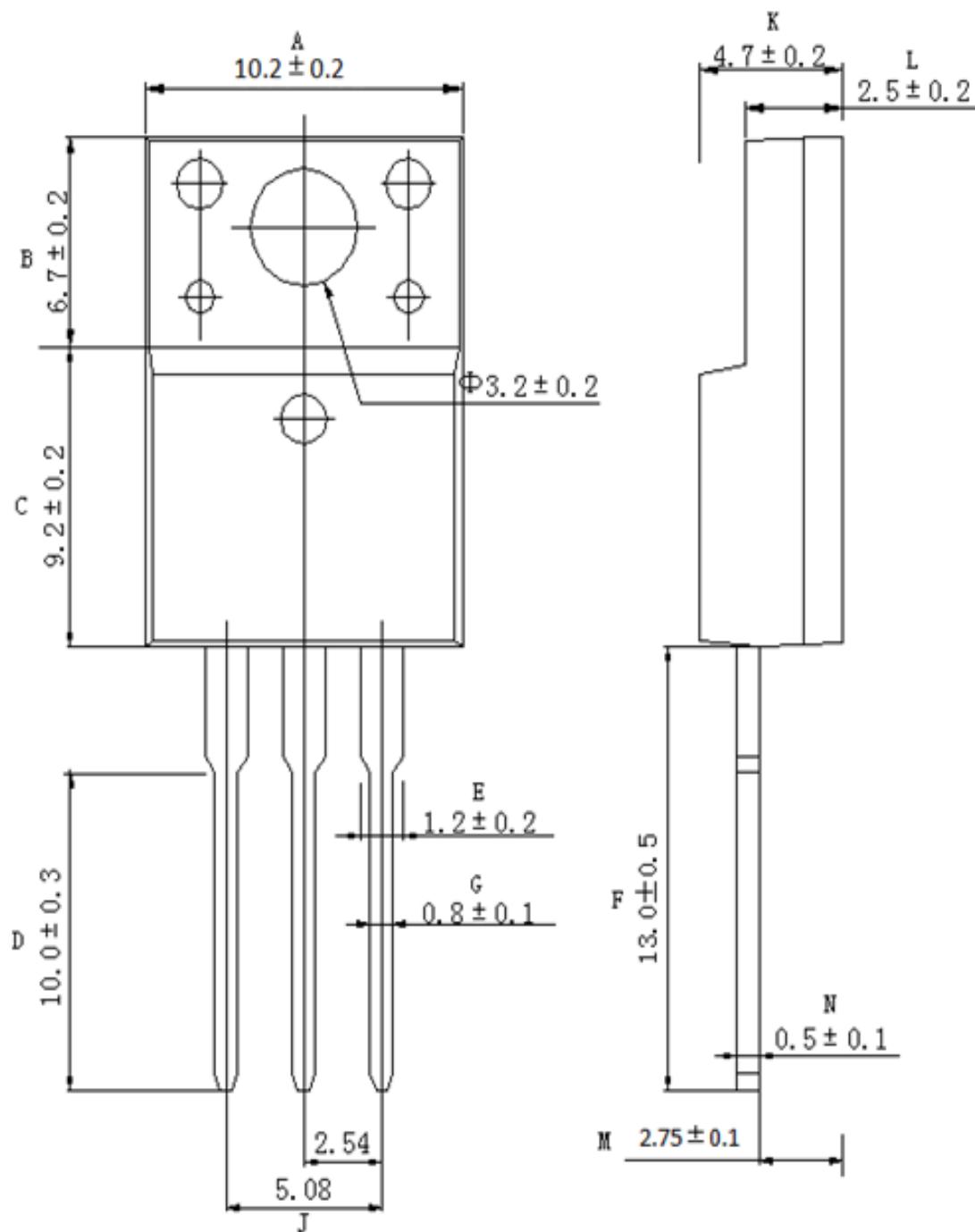


**Figure 10. Maximum Safe Operating Area
(TO-220F)**



N-Channel Enhancement Mode MOSFET

TO-220F Package Outline Data





FS7N65NF

N-Channel Enhancement Mode MOSFET

印字说明

印字说明

FS7N65NF

AABBCC

第一行标记为物料型号代码

第二行为AA为内部识别码，BB为表示年份，例如22即表示2022年，CC表示周期，例如01即表示第一周；
2201即表示2022年第一周生产。